

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number: [0015477752](#)
Status: **Active**
Description: 2.54mm (.100") Pitch C-Grid® Header, Through Hole, Dual Row, Vertical, High Temperature, Shrouded, with Peg, 52 Circuits, 0.76µm (30µ") Gold (Au) Selective Plating, Tin (Sn) PC Tail Plating

Documents:

3D Model	Product Specification PS-70567 (PDF)
Drawing (PDF)	RoHS Certificate of Compliance (PDF)

Agency Certification

CSA	LR19980
UL	E29179

General

Product Family	PCB Headers
Series	70568
Application	Wire-to-Board
Product Name	C-Grid®

Physical

Breakaway	No
Circuits (Loaded)	52
Color - Resin	Black
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Compliant	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Metal	Brass, Phosphor Bronze
Material - Plating Mating	Gold
Material - Resin	High Temperature Thermoplastic
Number of Rows	2
Orientation	Vertical
PC Tail Length (in)	0.130 In
PC Tail Length (mm)	3.30 mm
PCB Locator	No
PCB Retention	Yes
PCB Thickness Recommended (in)	0.093 In
PCB Thickness Recommended (mm)	2.40 mm
Packaging Type	Tube
Pitch - Mating Interface (in)	0.100 In
Pitch - Mating Interface (mm)	2.54 mm
Pitch - Term. Interface (in)	0.100 In
Pitch - Term. Interface (mm)	2.54 mm
Plating min: Mating (µin)	30
Plating min: Mating (µm)	0.76
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Shrouded	Fully
Stackable	No
Surface Mount Compatible (SMC)	No
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Through Hole

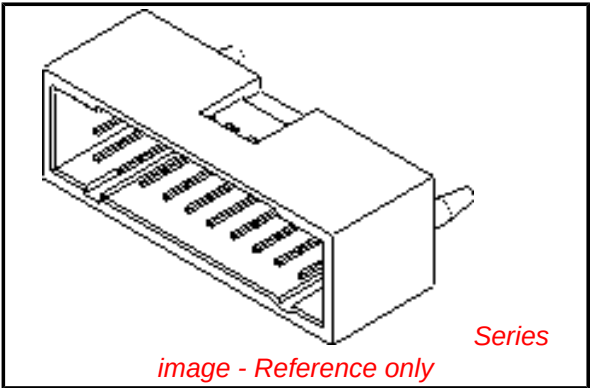


image - Reference only

EU RoHS

**ELV and RoHS
Compliant**
**REACH SVHC
Contains SVHC: No**
**Halogen-Free
Status**

Not Reviewed

China RoHS



**Need more information on product
environmental compliance?**

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of
Compliance, [click here](#)

Please visit the [Contact Us](#) section for any
non-product compliance questions.

Search Parts in this Series
[70568Series](#)

Electrical

Current - Maximum per Contact	2.5A
Voltage - Maximum	250V

Solder Process Data

Duration at Max. Process Temperature (seconds)	5
Lead-free Process Capability	SMC & Wave Capable (TH only)
Max. Cycles at Max. Process Temperature	1
Process Temperature max. C	245

Material Info

Old Part Number	A-70568-0092
-----------------	--------------

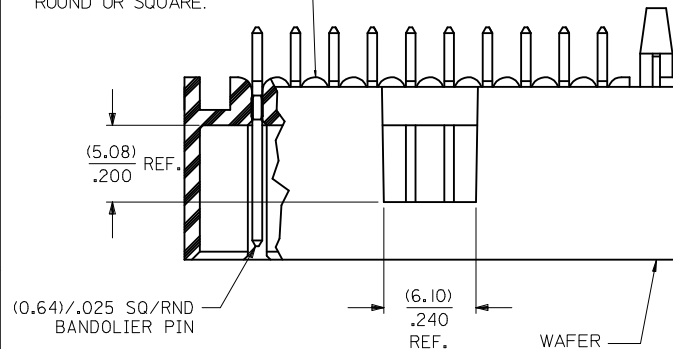
Reference - Drawing Numbers

Product Specification	PS-70567
Sales Drawing	SDA-70568-****

This document was generated on 03/31/2010

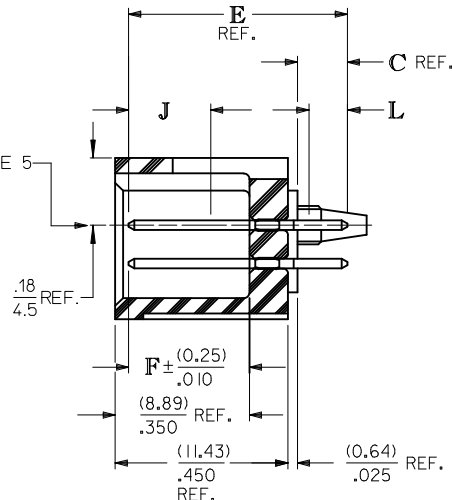
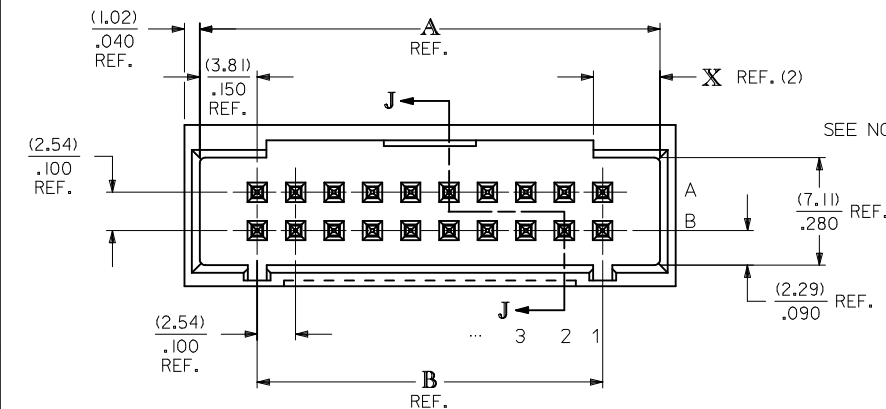
PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

STAND OFFS CAN BE EITHER
ROUND OR SQUARE.

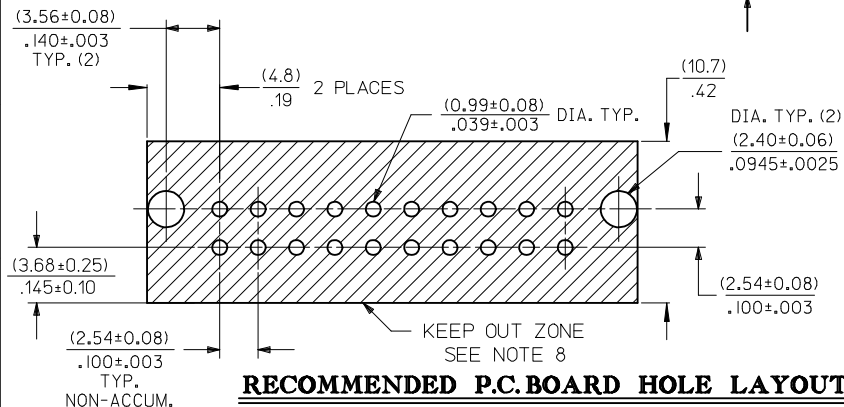
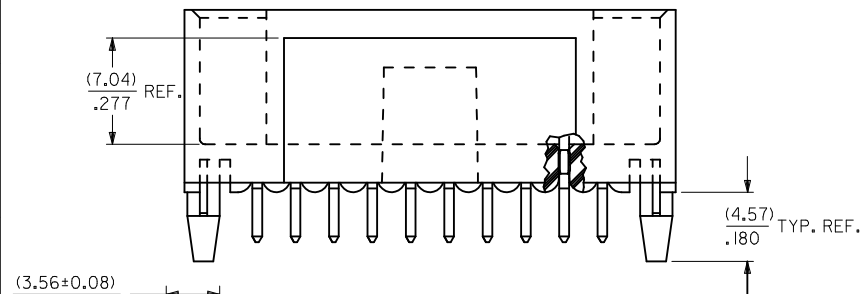


NOTES:

1. MATERIAL: WAFER - GLASS FILLED LIQUID CRYSTAL POLYMER, UL 94V-0, COLOR: BLACK, PIN: COPPER ALLOY.
2. PLATING: TIN
TIN(Sn) ALLOY OVER ENTIRE PIN: THICKNESS = (3.81 MICROMETER)/ 150 MICROINCH MINIMUM;
NICKEL (Ni) UNDERPLATE OVER ENTIRE PIN.
15 GOLD SELECTIVE GOLD (Au) IN THE CONTACT AREA: THICKNESS = (0.38 MICROMETER)/ 15 MICROINCH MINIMUM;
SELECTIVE TIN (Sn) ALLOY IN THE PC TAIL AREA: THICKNESS = (1.91 MICROMETER)/ 75 MICROINCH MINIMUM;
NICKEL (Ni) UNDERPLATE OVER ENTIRE PIN.
30 GOLD SELECTIVE GOLD (Au) IN THE CONTACT AREA: THICKNESS = (0.76 MICROMETER)/ 30 MICROINCH MINIMUM;
SELECTIVE TIN (Sn) ALLOY IN THE PC TAIL AREA: THICKNESS = (1.91 MICROMETER)/ 75 MICROINCH MINIMUM;
NICKEL (Ni) UNDERPLATE OVER ENTIRE PIN.
* THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH LEAD.
3. PRODUCT SPECIFICATION: PS-70567.
4. PACKAGING: SEE CHARTS
5. PIN PUSHOUT FORCE: 4 LBS. MIN. IN DIRECTION INDICATED.
6. FOR ILLUSTRATION PURPOSES, 20 (DUAL 10) CIRCUIT SIZE IS SHOWN.
7. PINS MUST MEET SOLDERABILITY SPEC. SMES-152.
EXCEPT VOIDS ARE PERMISSIBLE AT BANDOLIER PIN FAYING SURFACE. (APPROX. (0.64) / .025 LNG X (0.15) / .006 WD. REF.) - 2 LOCATIONS
8. NO FEATURES WHICH RISE ABOVE THE PCB SURFACE ALLOWED IN THIS AREA.
9. THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPEC PS-45499-002.



SECTION J-J



RECOMMENDED P.C. BOARD HOLE LAYOUT

CKT. SIZE	DIM. A REF.		DIM. B REF.		DIM. X REF.	
	(MM)	INCH	(MM)	INCH	(MM)	INCH
6	(12.70)	.500	(5.08)	.200	(3.18)	.125
8	(15.24)	.600	(7.62)	.300	(4.42)	.174
10	(17.78)	.700	(10.16)	.400	(4.42)	.174
12	(20.32)	.800	(12.70)	.500	(4.42)	.174
14	(22.86)	.900	(15.24)	.600	(4.42)	.174
16	(25.40)	1.000	(17.78)	.700	(4.42)	.174
18	(27.94)	1.100	(20.32)	.800	(4.42)	.174
20	(30.48)	1.200	(22.86)	.900	(4.42)	.174
22	(33.02)	1.300	(25.40)	1.000	(4.42)	.174
24	(35.56)	1.400	(27.94)	1.100	(4.42)	.174
26	(38.10)	1.500	(30.48)	1.200	(4.42)	.174
28	(40.64)	1.600	(33.02)	1.300	(4.42)	.174
30	(43.18)	1.700	(35.56)	1.400	(4.42)	.174
32	(45.72)	1.800	(38.10)	1.500	(4.42)	.174
34	(48.26)	1.900	(40.64)	1.600	(4.42)	.174
36	(50.80)	2.000	(43.18)	1.700	(4.42)	.174
38	(53.34)	2.100	(45.72)	1.800	(4.42)	.174
40	(55.88)	2.200	(48.26)	1.900	(4.42)	.174
42	(58.42)	2.300	(50.80)	2.000	(4.42)	.174
44	(60.96)	2.400	(53.34)	2.100	(4.42)	.174
46	(63.50)	2.500	(55.88)	2.200	(4.42)	.174
48	(66.04)	2.600	(58.42)	2.300	(4.42)	.174
50	(68.58)	2.700	(60.96)	2.400	(4.42)	.174
52	(71.12)	2.800	(63.50)	2.500	(4.42)	.174
54	(73.66)	2.900	(66.04)	2.600	(4.42)	.174
56	(76.20)	3.000	(68.58)	2.700	(4.42)	.174
58	(78.74)	3.100	(71.12)	2.800	(4.42)	.174
60	(81.28)	3.200	(73.66)	2.900	(4.42)	.174
62	(83.82)	3.300	(76.20)	3.000	(4.42)	.174
64	(86.36)	3.400	(78.74)	3.100	(4.42)	.174
66	(88.90)	3.500	(81.28)	3.200	(4.42)	.174
68	(91.44)	3.600	(83.82)	3.300	(4.42)	.174
70	(93.98)	3.700	(86.36)	3.400	(4.42)	.174
72	(96.52)	3.800	(88.90)	3.500	(4.42)	.174

2	G
1	H
SHT	REV

MODIFIED NOTES
EC NO: UCP2009-0336
DRAWN: KLOSTERMEIER 2008/09/23
CHKD: JEBELL 2008/09/24
APPR: FSMITH 2008/09/25

QUALITY
SYMBOLS
▽=0
▽=0

GENERAL TOLERANCES
(UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± .005	± .0005
3 PLACES	± .010	± .0010
2 PLACES	± .015	± .0015
1 PLACE	± .025	± .0025

ANGULAR ±1/2°

DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

DIMENSION STYLE
MM/IN

DRAWN BY DATE
SMR 1993/11/10

CHECKED BY DATE
SMR 1993/11/10

APPROVED BY DATE

MATERIAL NO.
SEE TABLE

SIZE
C

SCALE
4:1

DESIGN UNITS
INCH

THIRD ANGLE
PROJECTION

SALES ASSY - DUAL ROW
SHROUDED WAFER/HI TEMP
.25SQ/RND PINS .100 GRID

MOLEX INCORPORATED

DOCUMENT NO.
SDA-70568-****

SHEET NO.
1 OF 2

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX
INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

